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# E3272s HiLink Firmware Release Notes

## V1.0

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## Revision Record

Date	Revision version	FW-WebUI/HiLink Version	Change Description	Author
2013-10-12	1.0	22.436.11.00.673		hanhaijun

## Table of Contents

1	Main Features .....	4
2	Hardware.....	4
2.1	Hardware Specifications .....	4
3	Firmware.....	5
3.1	Version Description .....	5
3.2	Firmware Specifications .....	5
3.3	Improvement in the Previous Version .....	6
3.4	Known Limitations and Issues .....	6
4	WebUI/HiLink .....	6
4.1	Version Description .....	6
4.2	WebUI/HiLink Specifications .....	6
4.3	Improvement in the Previous Version .....	6
4.4	Known Limitations and Issues .....	6



# E3272s Firmware Release Notes V1.0

## 1 Main Features

The E3272s supports the following standards:

- LTE data service up to 130Mbit/s(Downlink) and 50Mbit/s(Uplink)
- DC-HSPA+ data service up to 43.2 Mbit/s
- HSPA+ data service up to 21.6 Mbit/s
- HSDPA packet data service of up to 14.4 Mbit/s
- HSUPA data service up to 5.76 Mbit/s
- WCDMA PS domain data service of up to 384 Kbit/s
- Equalizer and receive diversity
- microSD Card Slot (Up to 32G)
- Data and SMS Service
- HiLink features (Driverless, WEB UI, Auto connect)
- Plug and play
- Standard USB interface

## 2 Hardware

### 2.1 Hardware Specifications

Item	Specifications
Hardware Version	<ul style="list-style-type: none"><li>● CH1E3272SM</li></ul>
Technical standard	<ul style="list-style-type: none"><li>● LTE 3GPP R9</li><li>● HSPA+/UMTS: 3GPP R99/R5/R6/R7/R8</li><li>● GSM/GPRS/EDGE: 3GPP R99</li></ul>
External interfaces	USB: Type A with standard USB 2.0 High speed interface
	LED: indicating the status of the Data Card
	SD card: standard TF card interface
	SIM/USIM card: standard 6-pin SIM card interface
	RF interface: external RF interface
Maximum power consumption	≤ 3.5 W
Power supply	5V
Dimensions (D × W × H)	About 92mm(D) × 32mm(W) × 14mm (H)
Weight	≤ 50 g



Item	Specifications
Temperature	<ul style="list-style-type: none"><li>Operating: -10°C to +40°C</li><li>Storage: -20°C to +70°C</li></ul>
Humidity	5% to 95%
Base Information	<ul style="list-style-type: none"><li>Plug and play (PnP)</li></ul>
	<ul style="list-style-type: none"><li>Standard USB 2.0 High Speed interface, auto installation, convenient for use</li></ul>
<b>Note:</b> 3GPP = The 3rd Generation Partnership Project TS = Technical Specification LED = Light-Emitting Diode SIM = Subscriber Identity Module USIM = UMTS Subscriber Identity Module	

## 3 Firmware

### 3.1 Version Description

Firmware Version:	22.436.11.00.673
Baseline information	Balong V7R1 C32B236

### 3.2 Firmware Specifications

Firmware		
Item	Specifications	
Version	22.436.11.00.673	
Information	Platform	Balong V7R1
	Baseline	B236
	Feature	LTE Supported
Data service	GSM CS domain	<ul style="list-style-type: none"><li>Uplink: 9.6/14.4 kbit/s</li><li>Downlink: 9.6/14.4 kbit/s</li></ul>
	GPRS	<ul style="list-style-type: none"><li>Uplink: 85.6 kbit/s</li><li>Downlink: 85.6 kbit/s</li></ul>
	EDGE	<ul style="list-style-type: none"><li>Uplink: 236.8 kbit/s</li><li>Downlink: 236.8 kbit/s</li></ul>
	UMTS PS domain	<ul style="list-style-type: none"><li>Uplink: 384 kbit/s</li><li>Downlink: 384 kbit/s</li></ul>
	HSDPA	<ul style="list-style-type: none"><li>14.4Mbit/s</li></ul>
	HSUPA	<ul style="list-style-type: none"><li>5.76 Mbit/s</li></ul>



Firmware		
Item	Specifications	
	HSPA+	<ul style="list-style-type: none"><li>• 21.6Mbit/s</li></ul>
	DC HSPA+	<ul style="list-style-type: none"><li>• Uplink:5.76 Mbit/s</li><li>• Downlink:43.2Mbit/s</li></ul>
	LTE	<ul style="list-style-type: none"><li>• Uplink: 50Mbit/s</li><li>• Downlink:130Mbit/s</li></ul>
SMS	<ul style="list-style-type: none"><li>• SMS over SGs</li></ul>	
Operating System	<ul style="list-style-type: none"><li>• Windows XP/Windows Vista/WIN 7/MAC/WIN8</li></ul>	

### 3.3 Improvement in the Previous Version

Index	Case ID	Issue Description
1	New feature	<i>support IPV6, default double stack</i>

### 3.4 Known Limitations and Issues

Index	Case ID	Issue Description

## 4 WebUI/HiLink

### 4.1 Version Description

WebUI/HiLink Version: 13.100.04.01.673

### 4.2 WebUI/HiLink Specifications

Item	Specifications

### 4.3 Improvement in the Previous Version

Index	Case ID	Issue Description

### 4.4 Known Limitations and Issues

Index	Case ID	Issue Description
1		NA